

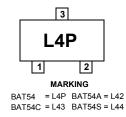
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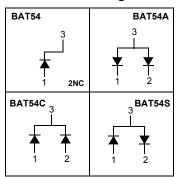


BAT54/A/C/S Schottky Diodes





Connection Diagram



Absolute Maximum Ratings * Ta = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V _{RRM}	Maximum Repetitive Reverse Voltage 30		V
I _{F(AV)}	Average Rectified Forward Current 200		mA
I _{FSM}	lon-repetitive Peak Forward Surge Current 600 mA Pulse Width = 1.0 second		mA
T _{STG}	Storage Temperature Range	-55 to +150	°C
T _J	Operating Junction Temperature	-55 to +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Unit
P_{D}	Power Dissipation	290	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	430	°C/W

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max.	Units
V _R	Breakdown Voltage	I _R = 10μA	30		V
V _F	Forward Voltage	$I_F = 0.1\text{mA}$ $I_F = 1\text{mA}$ $I_F = 10\text{mA}$ $I_F = 30\text{mA}$ $I_F = 100\text{mA}$		240 320 400 500 0.8	mV mV mV V
I _R	Reverse Leakage	V _R = 25V		2	μΑ
C _T	Total Capacitance	V _R = 1V, f = 1.0MHz		10	pF
t _{rr}	Reverse Recovery Time	$I_F = I_R = 10 \text{mA}, I_{RR} = 1.0 \text{mA},$ $R_L = 100 \Omega$		5.0	ns

Typical Performance Characteristics

Figure 1. Forward Voltage vs Temperature

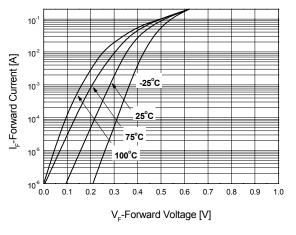


Figure 2. Reverse Leakage Current vs Temperature

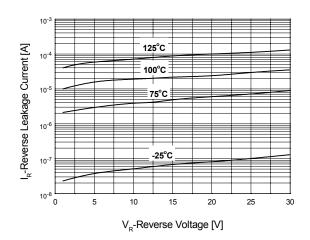
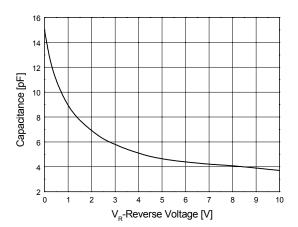


Figure 3. Capacitance vs Reverse Bias Voltage



2

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